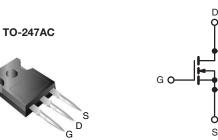


Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | |
|----------------------------|-----------------|-------|--|--|
| V _{DS} (V) | 500 | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 10 V$ | 0.135 | | |
| Q _g (Max.) (nC) | 190 | | | |
| Q _{gs} (nC) | 59 | | | |
| Q _{gd} (nC) | 84 | | | |
| Configuration | Single | | | |



FEATURES

• Low Gate Charge $\mathbf{Q}_{\mathbf{g}}$ Results in Simple Drive Requirement



RoHS

COMPLIANT

- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Low R_{DS(on)}
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- · Hard Switching and High Frequency Circuits

| ORDERING INFORMATION | |
|----------------------|----------------|
| Package | TO-247AC |
| Lead (Pb)-free | IRFP32N50KPbF |
| | SiHFP32N50K-E3 |
| SnPb | IRFP32N50K |
| | SiHFP32N50K |

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted) | | | | | | |
|---|-------------------------|---|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 500 | V | |
| Gate-Source Voltage | | | V _{GS} | ± 30 | v | |
| Continuous Drain Current | V _{GS} at 10 V | $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$ | - I _D | 32 | | |
| | | T _C = 100 °C | | 20 | А | |
| Pulsed Drain Current ^a | | | I _{DM} | 130 | | |
| Linear Derating Factor | | | | 3.7 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 450 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 32 | A | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 46 | mJ | |
| Maximum Power Dissipation | T _C = | 25 °C | PD | 460 | W | |
| Peak Diode Recovery dV/dtc | | | dV/dt | 13 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Soldering Recommendations (Peak Temperature) | for | 10 s | | 300 ^d | C | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ∙ in | |
| | | | | 1.1 | N · m | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. Starting T_J = 25 °C, L = 0.87 mH, R_g = 25 $\Omega,$ I_{AS} = 32 A.

c. $I_{SD} \le 32$ A, dl/dt ≤ 197 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | 40 | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.24 | - | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.26 | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|--|-----------|-----------|----------------------|------------------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_{D} = 250 \mu A$ | | 500 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | Reference to 25 °C, I _D = 1 mA | | 0.54 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | - | 5.0 | V |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 30 V | | - | ± 100 | nA |
| | I _{DSS} | V _{DS} = | $V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | - | 50 | |
| Zero Gate Voltage Drain Current | | V _{DS} = 400 \ | /, V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 32 A ^b | - | 0.135 | 0.16 | Ω |
| Forward Transconductance | g fs | V _{DS} | V _{DS} = 50 V, I _D = 32 A | | - | - | S |
| Dynamic | | | | | • | • | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 | | - | 5280 | - | - |
| Output Capacitance | Coss | | | - | 550 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 45 | - | |
| Output Consolitance | 0 | V _{GS} = 0 V | V _{DS} = 1.0 V, f = 1.0 MHz | - | 5630 | - | - pF |
| Output Capacitance | C _{oss} | | V _{DS} = 400 V, f = 1.0 MHz | - | 155 | - | |
| Effective Output Capacitance | Coss eff. | | V _{DS} = 0 V to 400 V ^c | - | 265 | - | |
| Total Gate Charge | Qg | | V _{GS} = 10 V I _D = 32 A, V _{DS} = 400 V ^b | - | - | 190 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 V$ | | - | - | 59 | |
| Gate-Drain Charge | Q _{gd} | | | | - | 84 | 1 |
| Turn-On Delay Time | t _{d(on)} | | | | 28 | - | |
| Rise Time | t _r | - V _{DD} = | = 250 V, I _D = 32 A, | - | 120 | - | 1 |
| Turn-Off Delay Time | t _{d(off)} | Rg = | $Rg = 4.3 \Omega, V_{GS} = 10 V^{b}$ | | 48 | - | - ns |
| Fall Time | t _f | 1 | | - | 54 | - | |
| Drain-Source Body Diode Characteristic | s | | | | | - | |
| Continuous Source-Drain Diode Current | I _S | showing the | MOSFET symbol showing the | | - | 32 | Α |
| Pulsed Diode Forward Current ^a | I _{SM} | p - n junction diode | | - | - | 130 | A |
| Body Diode Voltage | V _{SD} | $T_{J} = 25 \text{ °C}, I_{S} = 32 \text{ A}, V_{GS} = 0 \text{ V}^{b}$ | | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | - | 530 | 800 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | $T_J = 25 \text{ °C}, I_F = 32 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$ | | - | 9.0 | 13.5 | μC |
| Body Diode Reverse Recovery Current | I _{RRM} | | | - | 30 | - | Α |
| Forward Turn-On Time | t _{on} | Intrinsic tu | Irn-on time is negligible (turn | on is dor | ninated b | y L _S and | L _D) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. Pulse width $\leq 400~\mu s;$ duty cycle $\leq 2~\%.$

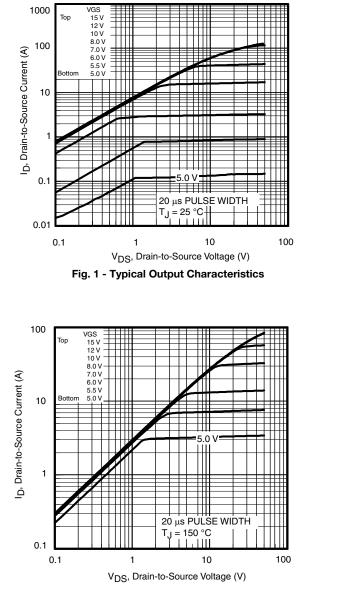
c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

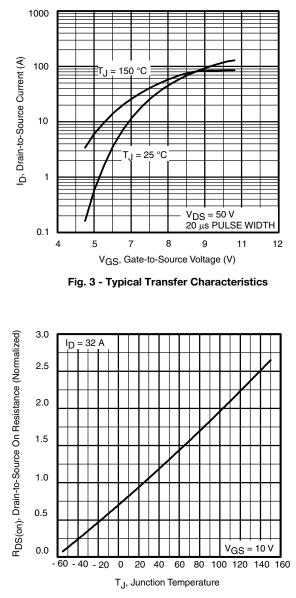


Fig. 4 - Normalized On-Resistance vs. Temperature

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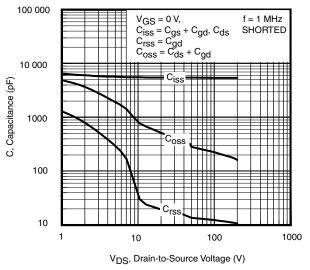


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

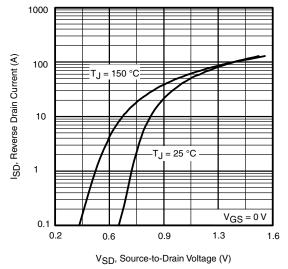


Fig. 7 - Typical Source-Drain Diode Forward Voltage

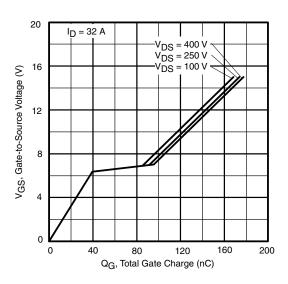


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

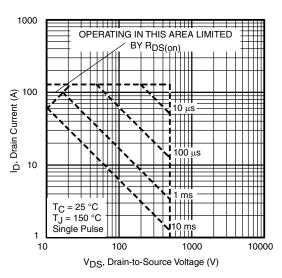


Fig. 8 - Maximum Safe Operating Area

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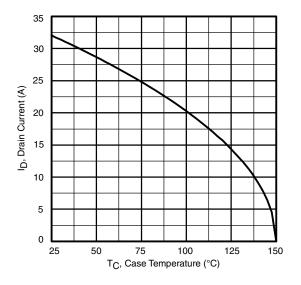


Fig. 9 - Maximum Drain Current vs. Case Temperature

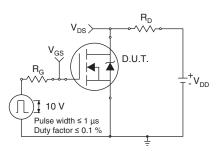


Fig. 10a - Switching Time Test Circuit

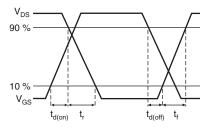


Fig. 10b - Switching Time Waveforms

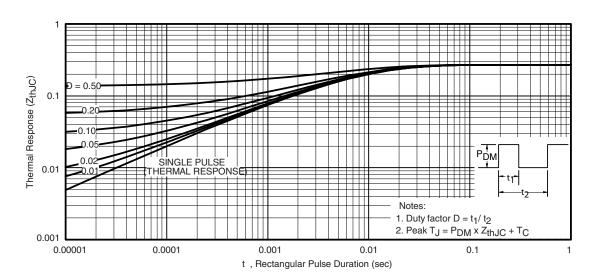


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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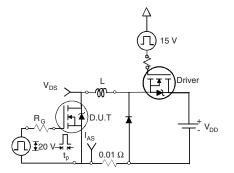


Fig. 12a - Unclamped Inductive Test Circuit

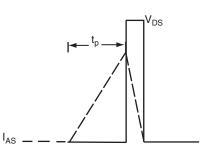


Fig. 12b - Unclamped Inductive Waveforms

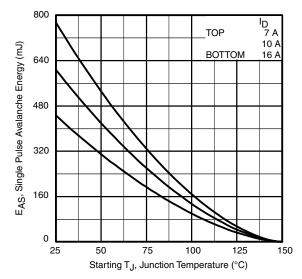


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

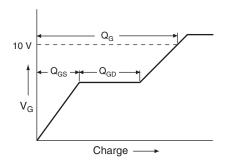


Fig. 13a - Basic Gate Charge Waveform

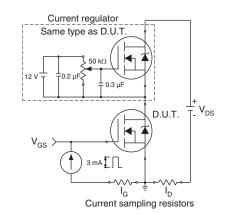


Fig. 13b - Gate Charge Test Circuit

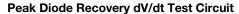
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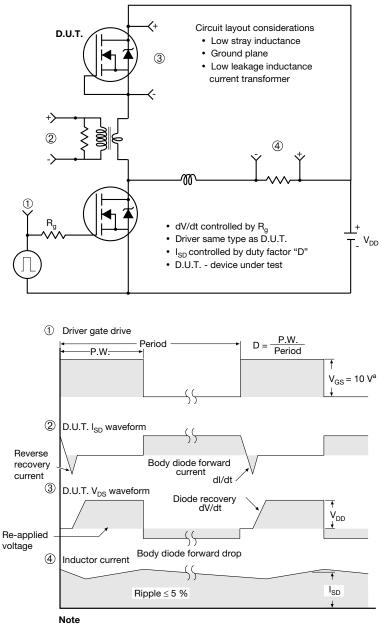
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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